University of Mumbai Examination 2020 under Cluster 06 (Lead College :- Vidyavardhini's College of Engineering & Technology)

Examinations Commencing from 7th January 2021 to 20th January 2021

Program: Electronics Engineering

Curriculum Scheme: Rev. 2019

Examination: S.E. Semester III

Course Code: ELC302 and Course Name: Electronic Devices & Circuits – I

Time: 2 hour

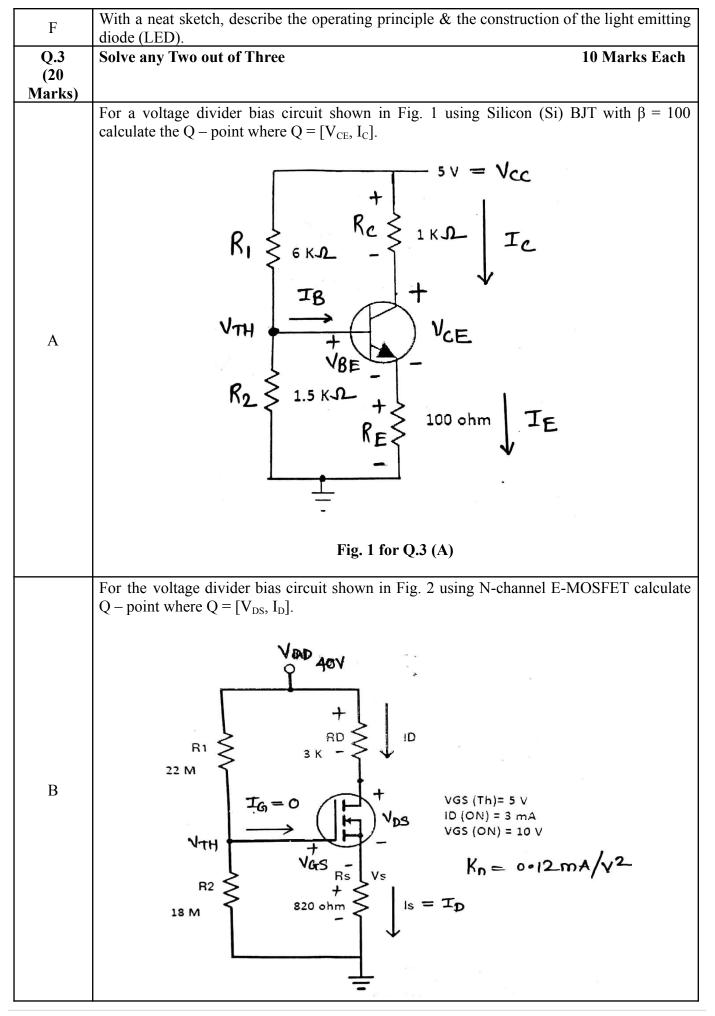
Max. Marks: 80

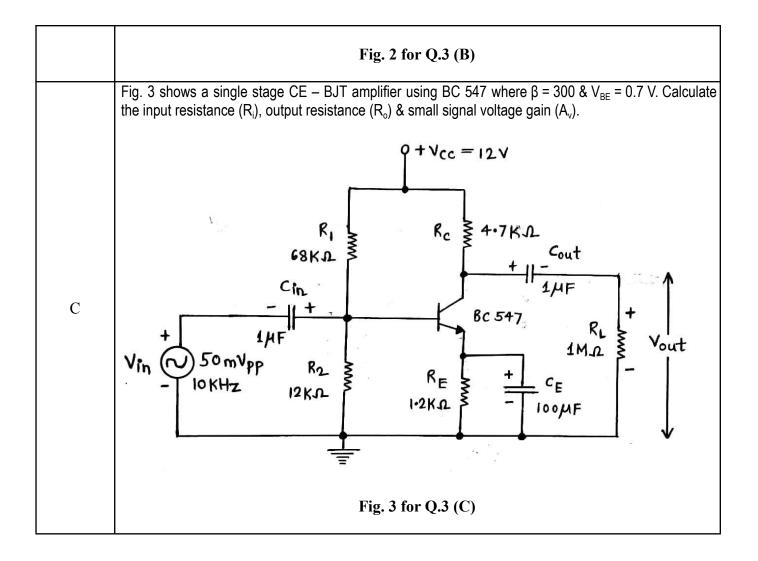
Q.1	Choose the correct option for following questions. All the Questions are compulsory	
	and carry equal marks.	
	The capacitance in a reverse biased PN junction is called as :-	
Option A:	Terminal capacitance	
Option B:	Junction capacitance	
Option C:	Diffusion capacitance	
Option D:	Transition capacitance	
2.	In any semiconductor material, the diffusion current is proportional to :-	
Option A:	Applied electric field	
Option B:	Concentration gradient of charge carriers	
Option C:	Square of applied electric field	
Option D:	Cube of applied electric field	
3.	The phenomenon of Zener breakdown occurs in :-	
Option A:	Heavily doped PN junction	
Option B: Lightly doped PN junction		
Option D:		
Option D:	Forward biased PN junction	
4.	Forward break-over voltage (V_{FBO}) of a typical silicon diode is approximately :-	
Option A:	0.6 V - 0.7 V	
Option B:	0.2 V – 0.3 V	
Option C:	1.1 V – 1.2 V	
Option D:	0.1 V - 0.2 V	
5.	When a reverse current in Zener diode increases from 20 mA to 30 mA, Zener voltage changes from 5.6 V to 5.65 V. The Zener resistance (r_z) is given by :-	
Option A:	2Ω	
Option B:	3 Ω	
Option C:	4Ω	
Option D:	5 Ω	
6.	In bipolar junction transistor (BJT) which mode of operation is not commonly used in real life applications ?	
Option A:	The inverse / reverse mode of operation	
Option B:	The cut-off mode of operation	
Option D:	The saturation mode of operation	
Option D:	The forward active / linear mode of operation	

7.	In bipolar junction transistor (BJT) the Early effect is due to :-	
Option A:	Decrease in width of the emitter due to reverse bias of collector-to-base junction	
Option B:		
Option C:		
Option D:	Temperature variations resulting in thermally generated minority carriers	
•		
8.	In PNP bipolar junction transistor (BJT), stream of current in active region is due to :-	
Option A:	Drift of holes	
Option B:	Drift of electrons	
Option C:	Diffusion of holes	
Option D:	Diffusion of electrons	
9.	In a bipolar junction transistor (BJT) if $\beta = 100$ & collector current (I _c) is 30 mA then what	
).	is the value of base current (I _B) ?	
Option A:	0.03 mA	
Option B:	0.3 mA	
Option C:	3 mA	
Option D:	300 mA	
10		
10.	The field effect transistor (FET) is :-	
Option A:	Power controlled device	
Option B:	Energy controlled device	
Option C:	Current controlled device	
Option D:	Voltage controlled device	
11.	Dinch off voltage in field offset transister (FET) is :	
Option A:	Pinch-off voltage in field effect transistor (FET) is :- Drain-to-source voltage giving zero (no) drain-to-source current	
Option B:	Drain-to-source voltage giving maximum drain-to-source current	
Option C:	Gate-to-source voltage giving zero (no) drain-to-source current	
	Gate-to-source voltage giving maximum drain-to-source current	
Option D.		
12.	Which of the following statement is not true for any field effect transistor (FET)?	
Option A:	FET has very high input resistance / impedance as compared to BJT	
Option B:	FET is a majority carrier operated (unipolar) device	
Option C:	FET has excellent operating stability against temperature variations compared to BJT	
Option D:	FET has higher transconductance compared to BJT	
<u>_</u>		
12	In junction field effect transistor (JFET), the amplification factor (μ) is expressed by which	
13.	of the following mathematical expressions ?	
Option A:	$\mu = g_m \times r_d$	
Option B:	$\mu = g_m + r_d$	
Option C:	$\mu = g_m - r_d$	
Option D:	$\mu = g_m / r_d$	
14.	For metal oxide semiconductor field effect transistor (MOSFET), the input impedance or the input metal (D_{1}, a_{1}, Z_{2}) is	
	the input resistance $(R_i \text{ or } Z_i)$ is :-	
Option A:	Less than JFET but more than BJT	
Option B:	More than both, JFET & BJT	
Option C:	More than JFET but less than BJT	
Option D:	Less than both, JFET & BJT	

15.	In MOSFET, which terminal is electrically isolated from the entire device structure ?		
Option A:	Source (S)		
Option B:			
Option C:			
Option D:	Bulk or Body or Substrate (SS)		
16.	In design of filters, which of these has the lowest value of ripple factor (γ)?		
Option A:	Capacitor (C) Filter		
Option B:	Inductor (L) Filter		
Option C:	Inductor & Capacitor (L-C) Filter		
Option D:	C-L-C or ' π ' Filter		
· ·			
17.	Maximum operating efficiency of a full wave bridge type rectifier to be considered during		
	the design process is :-		
Option A:	25 %		
Option B:	40.6 %		
Option C:	81.2 %		
Option D:	50 %		
18.	Which of these statements in not true for any type of BJT common base (CB) configuration		
10.	amplifier ?		
Option A:	It has a low input impedance / resistance		
Option B:	It has a high output impedance / resistance		
Option C:	It has moderate to high voltage gain		
Option D:	It produces a phase shift in amplified output signal with respect to input signal applied		
19.	Which process of electron-hole pair (EHP) is responsible for emitting of light ?		
Option A:	Recombination		
Option B:	Diffusion		
Option C:	Breakdown		
Option D:	Ionization		
20.	Which of these diodes does not work in the reverse bias mode of operation ?		
Option A:	Light emitting diode (LED)		
Option B:	Zener diode		
Option C:	Varactor diode		
Option D:	Photo diode		

Q.2	Solve any Four out of Six05 Marks Each
(20 Marks)	
A	Explain the effects of temperature on the $V - I$ characteristics of PN junction diode with a neat sketch / diagram & appropriate mathematical expressions.
В	Describe forward bias V – I characteristics of PN junction diode with neat labeled diagram & appropriate sketch.
С	Explain working of Center Tap type full wave rectifier with help of circuit diagram.
D	Discuss the working / operation of dual end clipper circuit with a neat labeled diagram showing appropriate waveforms of the resulting clipped output voltage.
Е	Explain the operation of Zener diode as a voltage regulator with a neat sketch for condition where supply / source voltage remains constant but load resistor varies.





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Q.1

Question No.	Correct Option (Enter either 'A' or 'B' or 'C' or 'D')
Q.1	D
Q.2	В
Q.3	А
Q.4	А
Q.5	D
Q.6	А
Q.7	В
Q.8	С
Q.9	В
Q.10	D
Q.11	С
Q.12	D
Q.13	А
Q.14	В
Q.15	С
Q.16	D
Q.17	С

Q.18	D
Q.19	А
Q.20	А

Q.2 (A) - Explain the effects of temperature on the V - I characteristics of PN junction diode with a neat sketch / diagram & appropriate mathematical expressions.

EFFECT OF TEMP. ON DIODE CHARACTERISTICS :know that the forward current through we diode is iven 61 = Is (e^{V0/nVT} Vo e DY ils e 10m VT W/hVT 00 g.:

 $\frac{1}{\eta V_T} = \log \left(\frac{If}{I_s} \right)$ $VO = \eta VT \log \left[\frac{Tf}{T}\right]$ The above Equation inditcates that forward voltage drop across diade depends upon the Revaue saturation current Is. The reverse sat-unation current Is of diade doubles in magnitude for every 10°C increase in temp., it means that increase in temp. increases Is, and hence forward voltage drop VD across diode decreases. From the canation (A), VO also depends upon the VT, but change in VT due to temp is comparatively less as change in Is. Thus increase in level of Is, will over power the smaller percentage change in VT. Thus as the temp of the diode increases then the forward voltage drop ie Vo decreases, hence, diade conducts catlica, due to which the forward characteristics of the diade moves to the left with increase in temperature. ID 1 200°C 100°C 25°C -75°C 0.7 R.15

Q.3 (A) – For the voltage divider bias circuit shown in Fig. 1 using silicon (Si) BJT with β = 100 calculate the Q – point where Q = [V_{CE}, I_C].

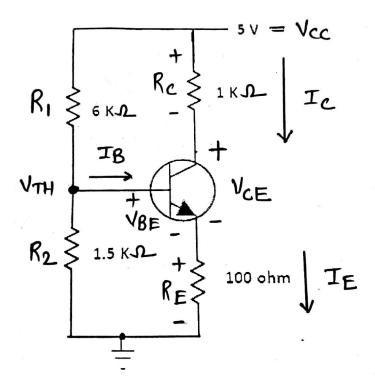


Fig. 1 for Q.3 (A)

(2) BJT Voltage Divider Bigsing
R_1 = 6KD & R_2 = 1.5KD
R_1 = 6KD & R_E = 100D
B = 100 & VBE = 0.7V
RTH = R_1 //R_2 = 6K // 1.5K = 1.2KD

$$\beta = 100 & VBE = 0.7V$$

RTH = $\frac{Vcc \cdot R_2}{R_1 + R_2} = \frac{5 \times 1.5K}{6K + 1.5K} = 1V \longrightarrow 2$
 $I_B = \frac{VTH - VBE}{R_{TH} + (1 + \beta)R_E} = \frac{1 - 0.7}{1.2K + (101) \times 100} = 26.55 \mu A \longrightarrow 3$
 $Tc = \beta \cdot TB = 100 \times 26.55 \times 10^{-6} = 2.65 m A \longrightarrow 4$
 $VcE = Vcc - Tc [R_c + R_E] = 5 - 2.65 [1 + 0.1] = 2.09V$
Hence $Q = [VcE, Tc] = [2.09V, 2.65 mA]$

Q.3 (B) – For the voltage divider bias circuit as shown in Fig. 2 using N-channel E-MOSFET calculate the Q – point where $Q = [V_{DS}, I_D]$.

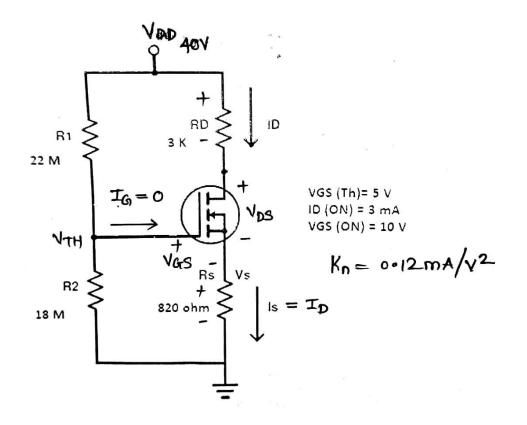


Fig. 2 for Q.3 (B)

E-MOSFET voltage Divider Bigsing

$$K_{n} = \frac{I_{D}(e_{N})}{\left[V_{GS}(e_{N}) - V_{GS}(\tau_{H})\right]^{2}} = \frac{3mA}{\left[10 - 5\right]^{2}} = 0.12 mA/v^{2}$$

$$V_{GS} = V_{TH} - I_{D}R_{S} = 18 - 0.82 I_{D} \longrightarrow 2$$

$$I_{D} = K_{n} \left[V_{GS} - V_{GS}(\tau_{H})\right]^{2} \longrightarrow 3$$

$$I_{D} = 0.12 \left[18 - 0.82 I_{D} - 5\right]^{2} \longrightarrow 4$$

$$\frac{|\text{Hence } I_{D} = 6.725 mA|}{|\text{VDS} = V_{DD} - I_{D} \left[R_{D} + R_{S}\right] = 40 - 6.725 \left[3 + 0.82\right] \rightarrow 6$$

$$\frac{|\text{Hence } V_{DS} = 14.31 V|}{|\text{Hence the } \text{Q-point is located at } \text{Q} = \left[V_{DS}, I_{D}\right]$$

$$Q = \left[14.31V, 6.725 mA\right]$$

Q.3 (C) - Fig. 3 shows a single stage CE – BJT amplifier using BC 547 where $\beta = 300$ & V_{BE} = 0.7 V. Calculate the input resistance (R_i), output resistance (R_o) & small signal voltage gain (A_v).

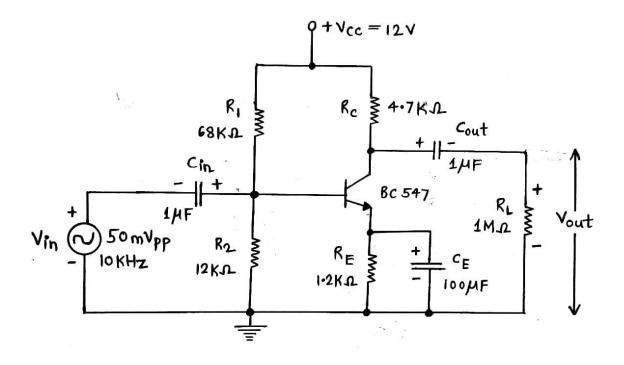


Fig. 3 for Q.3 (C)

$$\frac{Q.2(\alpha)}{VTH} = \frac{DC \text{ operating conditions } :-}{VTH} = \frac{V_{CC} \cdot R_{2}}{R_{1} + R_{2}} = \frac{12 \times 12K}{12K + 68K} = 1 \cdot 8 \vee \longrightarrow 0$$

$$R_{TH} = R_{1} / R_{2} = 68K / 12K = 10 \cdot 2 \text{ KD} \longrightarrow 2$$

$$T_{B} = \frac{VTH - V_{BE}}{RTH + (1 + \beta)R_{E}} = \frac{1 \cdot 8 - 0 \cdot 7}{10 \cdot 2K + (1 + 300) \times 1 \cdot 2K} = 2 \cdot 96 \mu \text{A}$$

$$T_{R} = \frac{26 \text{ mV}}{T_{B}} = \frac{26 \times 10^{-3}}{2 \cdot 96 \times 10^{-6}} = 8 \cdot 783 \text{ KD} \longrightarrow 4$$

$$AC \text{ operating conditions } :-$$

$$R_{1} = R_{1} / R_{2} / T_{\pi} = 68K / 12K / 8 \cdot 78K = 4 \cdot 72 \text{ KD} \longrightarrow 5$$

$$R_{0} = R_{C} = 4 \cdot 7 \text{ KD} \longrightarrow 6$$

$$Req = R_{E} / \left[\frac{T\pi}{1 + \beta}\right] = 1 \cdot 2K / 29 \cdot 28 = 28 \cdot 58 \cdot \Omega \longrightarrow 7$$

$$|A_{V}| = \left[R_{C} / R_{1}\right] \left[\frac{1 + \beta}{T_{\pi}}\right] = 160 \cdot 32 \longrightarrow 3$$